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April 1st, 2010
Renesas Electronics Corporation

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Renesas Technology Corp.
Customer Support Dept.
April 1, 2003

M32C/83 Group

Pulse width measurement with the Time measurement function of Intelligent I/O Group 0 and 1

1.0 Abstract

This application note shows the pulse width measurement operation, the time measurement function of the Intelligent I/O Group 0 and 1.

2.0 Introduction

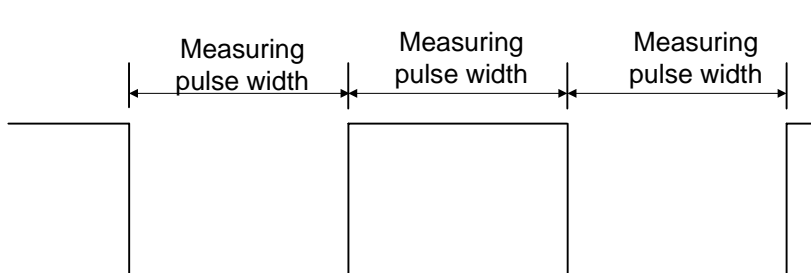
This application note is applied to the M32C/83 Group microcomputer only.

3.0 Detailed Description

Intelligent I/O Group 0 and 1 (Group 0 and Group 1) are composed of one 16-bit Base Timer for free-run operation and eight 16-bit registers for the time measurement function and waveform generation function.

This section shows how to measure the input pulse width applied to pin INPCO₀ by using the Channel 0 time measurement function.

Input pulse waveform



Intelligent I/O Group0 can measure maximum 8 channels of input pulses. And Intelligent I/O Group 1 can measure maximum 4 channels of input pulses.

(1) Time measurement function setting

This example will use Channel 0 in Group 0 for the pulse width measurement function. Select the both-edge mode for the trigger of the measurement.

(2) Pulse width calculation

Use the time measurement interrupt of Channel 0. Then, read the value of register GOTM0 during the interrupt routine.

Then calculate the difference from the value that is measured last time. This is the pulse width of the input pulse sectioned by two successive edges.

3.1 How to Set Up

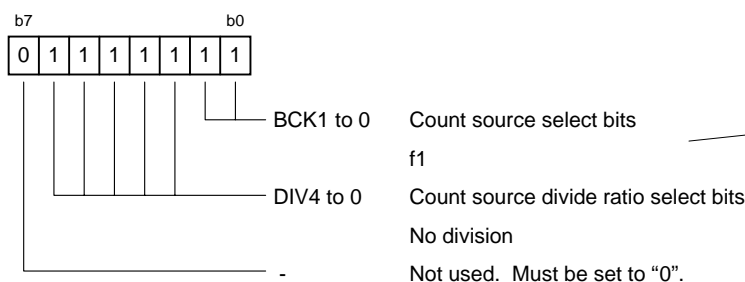
This section shows setting procedures and setting values to proceed section "3.0 Detailed Description". For detail configurations of each register, please refer to *M32C/83 Group Datasheet*.

(1) Inhibiting an Interrupt

Set I flag = 0. Or set bits ILV2 - 0 = 000₂ in register IIO0IC which the interrupt request of the Intelligent I/O is assigned in.

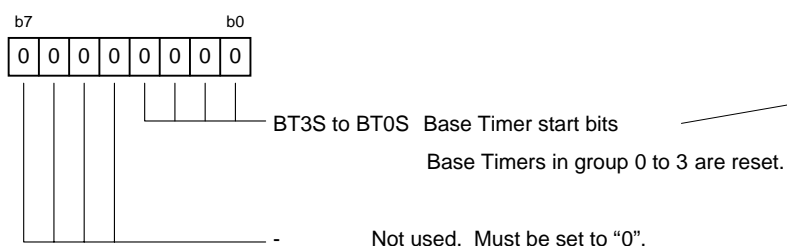
Then proceed the following register settings step by step.

(2) G0BCR0 Register



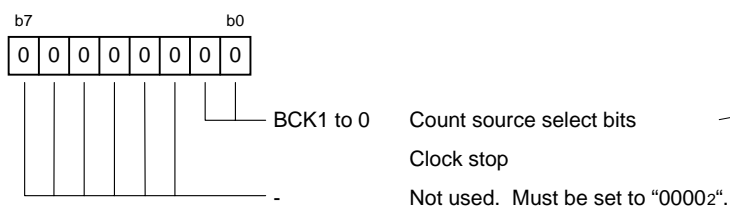
This setting allows using register BTSR.

(3) BTSR Register



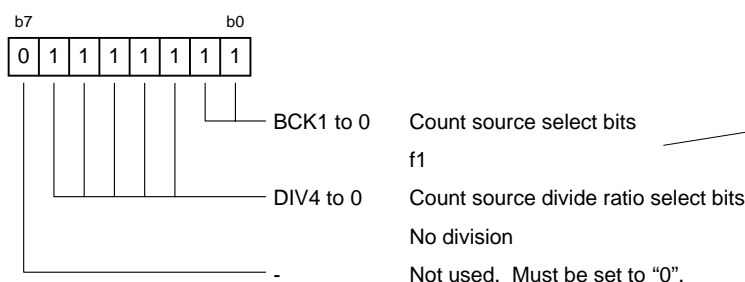
This setting resets Base Timers in Groups 0 to 3. Base Timer of Group i starts counting from 0x0000 by selecting a count source of Base Timer with register GiBCR0 and then set bit BTS = 1 in register GiBCR1.

(4) GiBCR0 Register (i= 1 to 3)



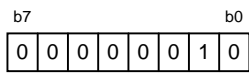
Set 0 to the BTSR register if Group 2 and the BTSR register is not used.

(5) G0BCR0 Register



Setting "01111111₂" to this register enables to set registers (6) thru (13).

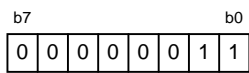
(6) G0BCR1 Register



- Not used. Must be set to "0".
- RST1 Base timer reset cause select bit 1
Base timer is reset by matching the GiPO0 register with the base timer.
- Not used. Must be set to "0".
- BTS Base Timer start bit
Base Timer reset
- UD1 to 0 Up/down control bits
Up-count mode
- Not used. Must be set to "0".

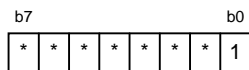
This bit must be set to "1" (base timer count start) after setting registers related to group 1.

(7) G0TMCR0 Register



- CTS0 to 1 Time measurement trigger select bits
Both edges
- DF0 to 1 Digital filter function select bits
No digital filter
- GT Gate function select bit
Not used gate function
- GOC Gate function release select bit
No effect
- GSC Gate function release bit
- PR prescaler function select bit
Not used

(8) G0FS Register

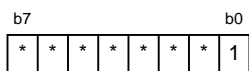


FSC0 Channel 0 time measurement function, waveform generation function select bit
 Select waveform generation function for channel 0.

FSC7 to 1 Channel 7 to 1 time measurement function, waveform generation function select bits
 If using channel j is used, the FSCj bit should be set "0" (waveform generation function selected).

Bit FSCj selects one from either the time measurement or wave generation functions. No error occurs if unused channels are set to either way, "0" or "1".

(9) G0FE Register

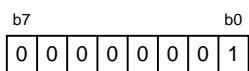


IFE0 Channel 0 function enable bit
 Channel 0 function is activated.

IFE7 to 1 Channel 7 to 1 function enable bits
 The IFEj bit should be set to "1" (channel j function activated) when using channel j.

Set 0 to bit IFEj if the respective channel j is not used.

(10) IIOkIE Register (k=0 to 11)

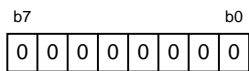


IRLT Interrupt request latch bit
 Interrupt request is not latch.

Bits 7 to 1 Interrupt enable bits 7 to 1
 Should set to "00000002".

Do not set 1 to bit IRLT and bits 7 - 1 at the same time.

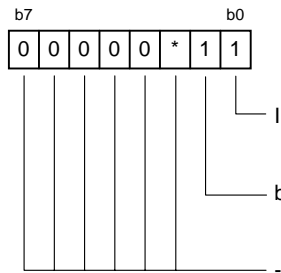
(11) IIOkIR Register (K=0 to 11)



Not used. Must be set to "0".
 Interrupt request flag is initialized.

00₁₆ must be set to register IIOkR.

(12) IIOkIE Register (k=0 to 11)



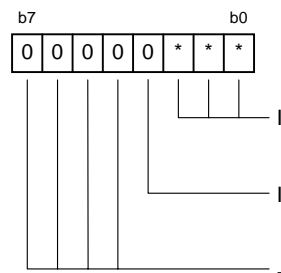
IRLT Interrupt request latch bit
 Interrupt request is latched.

bit 1 Interrupt enable bits 0
 This is set the corresponding POij bit to "1".

- Not used. Should set to "000002".

Clear the interrupt request bits of the unused interrupts by 0.

(13) IIOkIC Register (k=0 to 11)



ILVL2 to 0 Interrupt priority level select bits
 Interrupt priority level can be selected.

IR Interrupt request bit
 "No interrupt request" can be set.

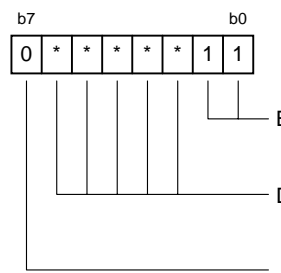
- Not used. Should set to "000002".

(14) PSC Register, PSLa(a=0 to 3) Register, PSb Register(b=0 to 9) IPS register

Ports to be used as the INPCij pin can be set by these registers.

(15) Interrupt enabled (I flag="1")

(16) G0BCR0 Register

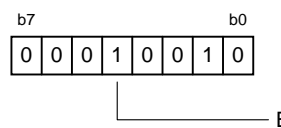


BCK1 to 0 Count source select bit
 f1

DIV4 to 0 Count source divide ratio select bit
 Divide ratio to be used should be set.

- Not used. Should set to "0".

(17) G0BCR1 Register



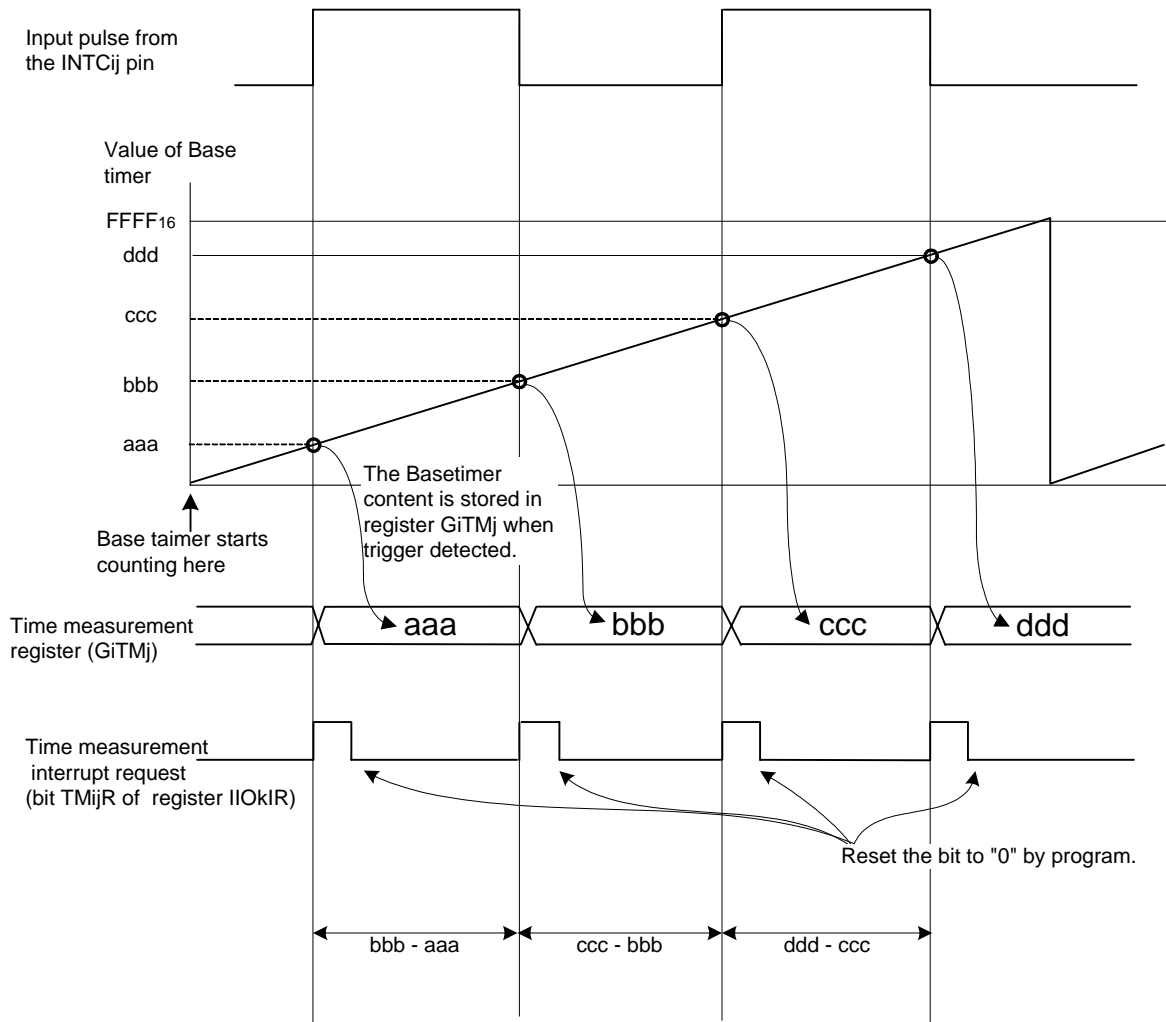
BTS Base timer start bit
 Base timer starts counting.

3.2 Precaution on Interrupts

During the Intelligent I/O interrupt routine, the IIOkIR register corresponding to this interrupt must be set to "0016" (initialized). If this setting is missing, the IR bit in the IIOkIC register is not set to "1" regardless of the Intelligent I/O interrupt request. (No interrupt occurs.)

3.3. Timing chart

The below is a timing diagram with settings according to the section 3.1 and 3.2.



4.0 Sample Programming Code

```

/*****
/*      FILENAME: apmc_80.c      *
/*      Ver       : 1.00        *
/*      CPU       : M32C/83     *
/*      FUNCTION: Intelligent I/O pulse width measuring *
/*-----*
/* Copyright (C) 2001 Mitsubishi Electric Corporation and *
/* Mitsubishi Electric Semiconductor Application          *
/* Engineering Corporation                               *
/* All rights reserved.                                  *
/*****/
/*****/
/* include file */
/*****/
#include <stdio.h>
#include "sfr83v101.h"

/*****/
/* Function Definition */
/*****/
void ch_int(void);
#pragma INTERRUPT ch0_int

/*****/
/* Global variable Definition */
/*****/
static short pulse;

/*****/
/* Main */
/*****/
void main(void){
    /* main clock set */
    prc0 = 1;          /* protect off */
    mcd = 0x12;       /* Main clock: not divided */
    prc0 = 0;         /* protect on */

    /* iio Group0 initial set */
    g2bcr0 = 0x7f;
    btsr = 0x00;      /* all Base Timer stop */
    g2bcr0 = 0x00;    /* Group2 clock stop */
    g0bcr0 = 0x7f;    /* b0,b1: count source = f1
                       b2-b6: divided rate: not divided*/

    g0bcr1 = 0x00;

    g0tmcr0 = 0x03;   /* measuring trigger: both edge */
    g0fs = 0x01;     /* ch0 select the time measuring function */
    g0fe = 0x01;     /* ch0 work the function */
    
```

```
/* iio Group0 interrupt initial set */
iio1ie = 0x01;      /* Interrupt request is used for an interrupt */
iio1ir = 0x00;      /* Clear a flag for interrupt request */
iio1ie = 0x03;      /* Enables corresponding interrupt from interrupt request flag */
iio1ic = 0x03;      /* Sets interrupt priority level */

/* port set */
ps1 = 0x00;
pd7 = 0x00;

/* interrupt enable */
_asm("fset i");

/* iio Group0 Base Timer start */
bts_g0bcr1 = 1;

while(1);

}

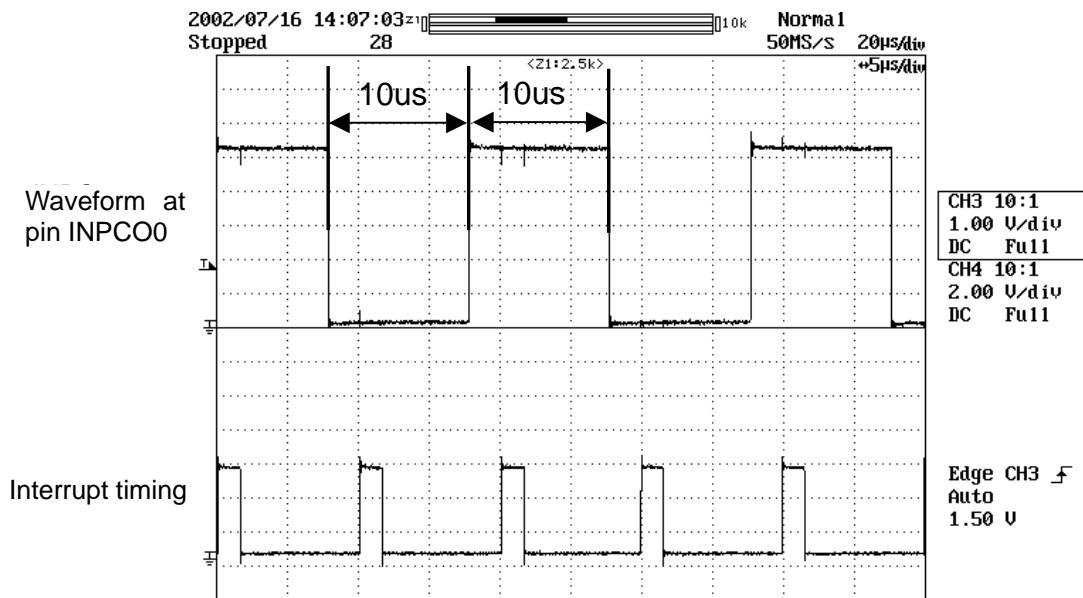
/* iio ch0 interrupt */
void ch0_int(void){
    static signed short old_tr = 0;
    short signed now_tr;
    iio1ir = 0x00;      /* Clear the interrupt request */
    now_tr = (signed short)g0tm0; /* Read time measurement register */
    pulse = now_tr - old_tr; /* Calculate the pulse width */
    old_tr = now_tr;    /* Save the latest register value */
}
/*----- program end */
```

5.0 Example Waveform and Result

The following example shows measuring a pulse width at pin INPC0 by using the Intelligent I/O Group 0.

- Conditions: Supply voltage = 5V
- Main clock (XIN) = 30MHz
- Base Timer operation clock (fBT) = 30MHz
- Input pulse = 50KHz

Result counts: 300
(300 / 30MHz = 10us)



Input pulse waveform and interrupt timing

6.0 Reference

Data Sheet

M32C/83 Group Rev. B3

(Use the latest version on the web: <http://www.infocom.maec.co.jp/M16C/dsum/32c83dse.htm>)

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